

2SK1255

Silicon N-Channel Power F-MOS

■ Features

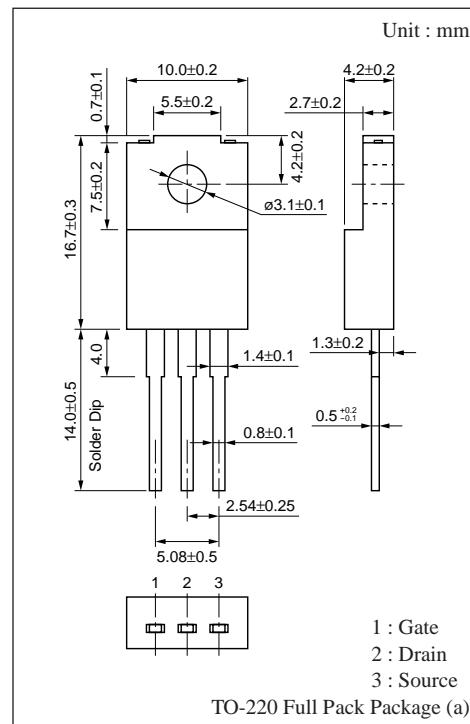
- Low ON-resistance $R_{DS(on)}$: $R_{DS(on)1} = 0.135\Omega$ (typ)
- High-speed switching : $t_f = 53\text{ns}$ (typ)
- No secondary breakdown
- Low-voltage drive

■ Applications

- DC-DC converter
- Non-contact relay
- Solenoid drive
- Motor drive

■ Absolute Maximum Ratings ($T_c = 25^\circ\text{C}$)

Parameter	Symbol	Rating	Unit
Drain-Source breakdown voltage	V_{DSS}	60	V
Gate-Source voltage	V_{GSS}	± 20	V
Drain current	at 4V drive	I_D	A
	DC	I_D	
	Pulse	I_{DP}	A
Allowable power dissipation	$T_c = 25^\circ\text{C}$	P_D	W
	$T_a = 25^\circ\text{C}$	30	
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$



■ Electrical Characteristics ($T_c = 25^\circ\text{C}$)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain-Source cut-off current	I_{DSS}	$V_{DS}=40\text{V}, V_{GS}=0$			10	μA
Gate-Source leakage current	I_{GSS}	$V_{GS}=\pm 20\text{V}, V_{DS}=0$			± 1	μA
Drain-Source breakdown voltage	V_{DSS}	$I_D=1\text{mA}, V_{GS}=0$	60			V
Gate threshold voltage	V_{th}	$V_{DS}=10\text{V}, I_D=1\text{mA}$	1		2.5	V
Drain-Source ON-resistance	$R_{DS(on) 1}$	$V_{GS}=10\text{V}, I_D=3\text{A}$		0.135	0.2	Ω
	$R_{DS(on) 2}$	$V_{GS}=4\text{V}, I_D=2\text{A}$		0.2	0.3	Ω
Forward transadmittance	$ Y_{fs} $	$V_{DS}=10\text{V}, I_D=3\text{A}$	2.4	4		S
Input capacitance	C_{iss}	$V_{DS}=10\text{V}, V_{GS}=0, f=1\text{MHz}$		400		pF
Output capacitance	C_{oss}			210		pF
Feedback capacitance	C_{rss}			80		pF
Turn-on time	t_{on}	$V_{GS}=10\text{V}, I_D=3\text{A}$		29		ns
Fall time	t_f			53		ns
Turn-off time (delay time)	$t_{d(off)}$			97		ns

